

DESCRIPTION/ORDERING INFORMATION

This dual-bit noninverting bus transceiver uses two separate configurable power-supply rails. The A port is designed to track V_{CCA} . V_{CCA} accepts any supply voltage from 1.2 V to 3.6 V. The B port is designed to track V_{CCB} . V_{CCB} accepts any supply voltage from 1.2 V to 3.6 V. This allows for universal low-voltage bidirectional translation between any of the 1.2-V, 1.5-V, 1.8-V, 2.5-V, and 3.3-V voltage nodes.

The SN74AVC2T45 is designed for asynchronous communication between data buses. The device transmits data from the A bus to the B bus or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input.

The SN74AVC2T45 is designed so that the DIR input is powered by V_{CCA} .

T _A	PACKAGE ⁽¹⁾		ORDERABLE PART NUMBER	TOP-SIDE MARKING ⁽²⁾
	NanoStar™ – WCSP (DSBGA) 0.23-mm Large Bump – YEP	Tana and mal	SN74AVC2T45YEPR	TP LOOM
–40°C to 85°C	NanoFree™ – WCSP (DSBGA) 0.23-mm Large Bump – YZP (Pb-free)	- Tape and reel	SN74AVC2T45YZPR	TD_
	SSOP – DCT	Tape and reel	SN74AVC2T45DCTR	DT2
V	VSSOP – DCU	Tape and reel	SN74AVC2T45DCUR	DT2_

ORDERING INFORMATION

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

(2) DCT: The actual top-side marking has three additional characters that designate the year, month, and assembly/test site. DCU: The actual top-side marking has one additional character that designates the assembly/test site. YEP/YZP: The actual top-side marking has three preceding characters to denote year, month, and sequence code, and one following character to designate the assembly/test site. Pin 1 identifier indicates solder-bump composition (1 = SnPb, · = Pb-free).



PDPlease be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

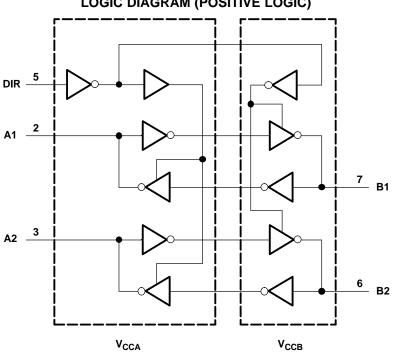
This device is fully specified for partial-power-down applications using I_{off} . The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

The V_{CC} isolation feature ensures that if either V_{CC} input is at GND, both ports are in the high-impedance state.

NanoStar[™] and NanoFree[™] package technology is a major breakthrough in IC packaging concepts, using the die as the package.

> **FUNCTION TABLE** (EACH TRANSCEIVER)

(=/(•)	
INPUT	OPERATION
DIR	OFERATION
L	B data to A bus
Н	A data to B bus



LOGIC DIAGRAM (POSITIVE LOGIC)



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Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V _{CCA} V _{CCB}	Supply voltage range		-0.5	4.6	V
		I/O ports (A port)	-0.5	4.6	
VI	Input voltage range ⁽²⁾	I/O ports (B port)	-0.5	4.6	V
		Control inputs	-0.5	4.6	
V	Voltage range applied to any output in the high-impedance or	A port	-0.5	4.6	V
Vo	power-off state ⁽²⁾	B port	-0.5	4.6	v
N/		A port	-0.5	V _{CCA} + 0.5	V
Vo	Voltage range applied to any output in the high or low state ⁽²⁾⁽³⁾	B port	-0.5	V _{CCB} + 0.5	v
I _{IK}	Input clamp current	V ₁ < 0		-50	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
I _O	Continuous output current			±50	mA
	Continuous current through V _{CCA} , V _{CCB} , or GND			±100	mA
		DCT package		220	
θ_{JA}	Package thermal impedance ⁽⁴⁾	DCU package		227	°C/W
		YEP/YZP package		102	
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed. The output positive-voltage rating may be exceeded up to 4.6 V maximum if the output current ratings are observed. (2)

(3) (4)

The package thermal impedance is calculated in accordance with JESD 51-7.

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Recommended Operating Conditions⁽¹⁾⁽²⁾⁽³⁾⁽⁴⁾⁽⁵⁾

			V _{CCI}	V _{cco}	MIN	MAX	UNIT
V _{CCA}	Supply voltage				1.2	3.6	V
V _{CCB}	Supply voltage				1.2	3.6	V
			1.2 V to 1.95 V		$V_{CCI} imes 0.65$		
VIH	High-level input voltage	Data inputs ⁽⁴⁾	1.95 V to 2.7 V		1.6		V
	input voltage		2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			$V_{CCI} imes 0.35$	
V _{IL}	Low-level input voltage	Data inputs ⁽⁴⁾	1.95 V to 2.7 V			0.7	V
	input voltage		2.7 V to 3.6 V			0.8	
			1.2 V to 1.95 V		$V_{CCA} imes 0.65$		
V _{IH}	High-level input voltage	DIR (referenced to V _{CCA}) ⁽⁵⁾	1.95 V to 2.7 V		1.6		V
	input voltage		2.7 V to 3.6 V		2		
			1.2 V to 1.95 V			$V_{CCA} imes 0.35$	
V _{IL}	Low-level input voltage	DIR (referenced to V _{CCA}) ⁽⁵⁾	1.95 V to 2.7 V			0.7	V
	input voltago		2.7 V to 3.6 V			0.8	
VI	Input voltage				0	3.6	V
V	Outrast selta aa	Active state			0	V _{cco}	V
Vo	Output voltage	3-state			0	3.6	V
				1.2 V		-3	
				1.4 V to 1.6 V		-6	
I _{OH}	High-level output	current		1.65 V to 1.95 V		-8	mA
				2.3 V to 2.7 V		-9	
				3 V to 3.6 V		-12	
				1.2 V		3	
				1.4 V to 1.6 V		6	
I _{OL}	Low-level output of	current		1.65 V to 1.95 V		8	mA
				2.3 V to 2.7 V		9	
				3 V to 3.6 V		12	
$\Delta t / \Delta v$	Input transition ris	e or fall rate				5	ns/V
T _A	Operating free-air	temperature			-40	85	°C

V_{CCI} is the V_{CC} associated with the data input port.
V_{CCO} is the V_{CC} associated with the output port.
All unused data inputs of the device must be held at V_{CCI} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.
For V_{CCI} values not specified in the data sheet, V_{IH(min)} = V_{CCI} x 0.7 V, V_{IL(max)} = V_{CCI} x 0.3 V.
For V_{CCI} values not specified in the data sheet, V_{IH(min)} = V_{CCA} x 0.7 V, V_{IL(max)} = V_{CCA} x 0.3 V.



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Electrical Characteristics⁽¹⁾⁽²⁾

over recommended operating free-air temperature range (unless otherwise noted)

	METER	TEST COND		V	V	TA	λ = 25°C		–40°C to	85°C	UNIT
PARA	MEIER	TEST COND	TIONS	V _{CCA}	V _{CCB}	MIN	TYP	MAX	MIN	MAX	UNIT
		I _{OH} = -100 μA		1.2 V to 3.6 V	1.2 V to 3.6 V				V _{CCO} - 0.2 V		
		I _{OH} = -3 mA		1.2 V	1.2 V		0.95				
V _{ОН}		$I_{OH} = -6 \text{ mA}$	$V_I = V_{IH}$	1.4 V	1.4 V				1.05		V
		$I_{OH} = -8 \text{ mA}$		1.65 V	1.65 V				1.2		
		$I_{OH} = -9 \text{ mA}$		2.3 V	2.3 V				1.75		
		I _{OH} = -12 mA		3 V	3 V				2.3		
		$I_{OL} = 100 \ \mu A$		1.2 V to 3.6 V	1.2 V to 3.6 V					0.2	
		I _{OL} = 3 mA		1.2 V	1.2 V		0.25				
V		$I_{OL} = 6 \text{ mA}$	$V_{I} = V_{IL}$	1.4 V	1.4 V					0.35	V
V _{OL}		I _{OL} = 8 mA	$v_{I} = v_{IL}$	1.65 V	1.65 V					0.45	v
		$I_{OL} = 9 \text{ mA}$		2.3 V	2.3 V					0.55	
		I _{OL} = 12 mA		3 V	3 V					0.7	
	DIR input	$V_{I} = V_{CCA}$ or GNE)	1.2 V to 3.6 V	1.2 V to 3.6 V		±0.025	±0.25		±1	μA
	A port	V_1 or $V_0 = 0$ to 3.	e V	0 V	0 to 3.6 V		±0.1	±1		±5	۸
I _{off}	B port	$v_1 \text{ or } v_0 = 0 \text{ to } 3.1$	o v	0 to 3.6 V	0 V		±0.1	±1		±5	μA
	A or B ports	$V_{O} = V_{CCO} \text{ or } GN$	D	1.2 V to 3.6 V	1.2 V to 3.6 V		±0.5	±2.5		±5	μA
				1.2 V to 3.6 V	1.2 V to 3.6 V					10	
I _{CCA}		V _I = V _{CCI} or GND,	$I_{O} = 0$	0 V	3.6 V					-2	μA
		GIND,		3.6 V	0 V					10	
				1.2 V to 3.6 V	1.2 V to 3.6 V					10	
I _{CCB}		V _I = V _{CCI} or GND,	$I_{O} = 0$	0 V	3.6 V					10	μA
		0.12,		3.6 V	0 V					-2	
I _{CCA} +	I _{CCB}	$V_I = V_{CCI}$ or GND,	$I_{O} = 0$	1.2 V to 3.6 V	1.2 V to 3.6 V					20	μA
	Control inputs	V _I = 3.3 V or GNI)	3.3 V	3.3 V		2.5				pF
	A or B ports	$V_{O} = 3.3 \text{ V or GN}$	D	3.3 V	3.3 V		6				pF

 $\begin{array}{ll} \mbox{(1)} & V_{CCO} \mbox{ is the } V_{CC} \mbox{ associated with the output port.} \\ \mbox{(2)} & V_{CCI} \mbox{ is the } V_{CC} \mbox{ associated with the input port.} \end{array}$



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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.2 V (see Figure 11)

	FROM	то	V _{CCB} = 1.2 V	V _{CCB} = 1.5 V	V _{CCB} = 1.8 V	V _{CCB} = 2.5 V	V _{CCB} = 3.3 V																			
PARAMETER	(INPUT)	(OUTPUT)	TYP	ТҮР	ТҮР	ТҮР	TYP	UNIT																		
t _{PLH}	٨	5	3.1	2.6	2.4	2.2	2.2																			
t _{PHL}	A	В	3.1	2.6	2.4	2.2	2.2	ns																		
t _{PLH}	В	•	3.4	3.1	3	2.9	2.9																			
t _{PHL}	Б	A	3.4	3.1	3	2.9	2.9	ns																		
t _{PHZ}	DIR	^	5.2	5.2	5.1	5	4.8	ns																		
t _{PLZ}	DIR	A	5.2	5.2	5.1	5	4.8	113																		
t _{PHZ}	DIR	В	5	4	3.8	2.8	3.2																			
t _{PLZ}	DIR	Б	5	4	3.8	2.8	3.2	ns																		
t _{PZH} ⁽¹⁾	סוס	^	8.4	7.1	6.8	5.7	6.1																			
t _{PZL} ⁽¹⁾	DIR	A	8.4	7.1	6.8	5.7	6.1	ns																		
t _{PZH} ⁽¹⁾	DID		8.3	7.8	7.5	7.2	7																			
t _{PZL} ⁽¹⁾	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	В	8.3	7.8	7.5	7.2	7	ns

(1) The enable time is a calculated value, derived using the formula shown in the enable times section.

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.5 V \pm 0.1 V (see Figure 11)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.1		V _{ССВ} = ± 0.1		$\begin{array}{c} \text{V}_{\text{CCB}} = 2.5 \text{ V} \\ \pm \text{ 0.2 V} \end{array}$		$V_{CCB} = 3.3 V \\ \pm 0.3 V$		UNIT								
	(INPUT)	(001901)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX									
t _{PLH}	А	В	2.8	0.7	5.4	0.5	4.6	0.4	3.7	0.3	3.5	20								
t _{PHL}	A	Б	2.8	0.7	5.4	0.5	4.6	0.4	3.7	0.3	3.5	ns								
t _{PLH}	В	А	2.7	0.8	5.4	0.7	5.2	0.6	4.9	0.5	4.7	ns								
t _{PHL}	D	A	2.7	0.8	5.4	0.7	5.2	0.6	4.9	0.5	4.7	115								
t _{PHZ}	DIR	А	3.9	1.3	8.5	1.3	7.8	1.1	7.7	1.4	7.6	20								
t _{PLZ}	DIK	A	3.9	1.3	8.5	1.3	7.8	1.1	7.7	1.4	7.6	ns								
t _{PHZ}	DIR	В	4.7	1.1	7	1.4	6.9	1.2	6.9	1.7	7.1	20								
t _{PLZ}	DIK	Б	4.7	1.1	7	1.4	6.9	1.2	6.9	1.7	7.1	ns								
t _{PZH} ⁽¹⁾	DIR	•	7.4		12.4		12.1		11.8		11.8									
t _{PZL} ⁽¹⁾	DIR	A	7.4		12.4		12.1		11.8		11.8	ns								
t _{PZH} ⁽¹⁾		DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	Р	6.7		13.9		11.6		9.1		7.8	20
t _{PZL} ⁽¹⁾	DIR									DIR	DIR	DIR	DIR	DIR B	6.7		13.9		11.6	

(1) The enable time is a calculated value, derived using the formula shown in the enable times section.



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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 1.8 V \pm 0.15 V (see Figure 11)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.1		V _{ССВ} = ± 0.1		V _{CCB} = ± 0.2		V _{CCB} = 3.3 V ± 0.3 V		UNIT																	
	(INFUT)	(001201)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX																		
t _{PLH}	А	В	2.7	0.5	5.2	0.4	4.3	0.2	3.4	0.2	3.1	20																	
t _{PHL}	A	Б	2.7	0.5	5.2	0.4	4.3	0.2	3.4	0.2	3.1	ns																	
t _{PLH}	В	А	2.4	0.7	4.7	0.5	4.4	0.5	4	0.4	3.8	20																	
t _{PHL}	Б	A	2.4	0.7	4.7	0.5	4.4	0.5	4	0.4	3.8	ns																	
t _{PHZ}	DIR	А	3.7	1.3	8.1	0.7	6.9	1.4	5.3	1.1	4.5	ns																	
t _{PLZ}	DIR	А	3.7	1.3	8.1	0.7	6.9	1.4	5.3	1.1	4.5	115																	
t _{PHZ}	DIR	В	4.4	1.3	5.8	1.3	5.9	0.8	5.7	1.5	5.9	20																	
t _{PLZ}	DIR	Б	4.4	1.3	5.8	1.3	5.9	0.8	5.7	1.5	5.9	ns																	
t _{PZH} ⁽¹⁾	DID	DID		DID	DID		А	6.8		10.4		10.3		9.7		9.7	20												
t _{PZL} ⁽¹⁾	DIR	A	6.8		10.4		10.3		9.7		9.7	ns																	
t _{PZH} ⁽¹⁾	DIR	DIR	P	6.4		13.3		11.2		8.6		7.4	20																
t _{PZL} ⁽¹⁾			DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	В	6.4		13.3		11.2		8.6	

(1) The enable time is a calculated value, derived using the formula shown in the enable times section.

Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 2.5 V \pm 0.2 V (see Figure 11)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{CCB} = ± 0.1	1.5 V I V	V _{CCB} = 1.8 V ± 0.15 V		V V _{CCB} = 2.5 V ± 0.2 V		V _{CCB} = 3.3 V ± 0.3 V		UNIT									
	(INPUT)	(001201)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX										
t _{PLH}	А	В	2.6	0.4	4.9	0.2	4	0.2	3	0.2	2.6	20									
t _{PHL}	A	Б	2.6	0.4	4.9	0.2	4	0.2	3	0.2	2.6	ns									
t _{PLH}	В	А	2.1	0.6	3.8	0.5	3.4	0.4	3	0.3	2.8	20									
t _{PHL}	Б	А	A	2.1	0.6	3.8	0.5	3.4	0.4	3	0.3	2.8	ns								
t _{PHZ}	DIR	^	2.4	0.7	7.9	0.8	6.4	0.8	5	0.5	4.3	20									
t _{PLZ}	DIR	A	2.4	0.7	7.9	0.8	6.4	0.8	5	0.5	4.3	ns									
t _{PHZ}	DIR	В	3.8	1	4.3	0.6	4.3	0.5	4.2	1.1	4.1	20									
t _{PLZ}	DIR	Б	3.8	1	4.3	0.6	4.3	0.5	4.2	1.1	4.1	ns									
t _{PZH} ⁽¹⁾	DID		DID	^	5.9		7.9		7.7		7.2		6.9	20							
t _{PZL} ⁽¹⁾	DIR	A	5.9		7.9		7.7		7.2		6.9	ns									
t _{PZH} ⁽¹⁾	DIR	DIR	DIR	P	5		12.8		10.4		7.9		6.8	20							
t _{PZL} ⁽¹⁾				DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	DIR	В	5		12.8		10.4		7.9

(1) The enable time is a calculated value, derived using the formula shown in the enable times section.



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Switching Characteristics

over recommended operating free-air temperature range, V_{CCA} = 3.3 V \pm 0.3 V (see Figure 11)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CCB} = 1.2 V	V _{ССВ} = ± 0.1		V _{ССВ} = ± 0.1		V _{CCB} = ± 0.2		V_{CCB} = 3.3 V ± 0.3 V		UNIT					
	(INFOT)	(001201)	TYP	MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX						
t _{PLH}	А	В	2.5	0.3	4.7	0.2	3.8	0.2	2.8	0.2	2.4	~~					
t _{PHL}	A	Б	2.5	0.3	4.7	0.2	3.8	0.2	2.8	0.2	2.4	ns					
t _{PLH}	В	А	2.1	0.6	3.6	0.4	3.1	0.3	2.6	0.3	2.4	20					
t _{PHL}	Б	A	2.1	0.6	3.6	0.4	3.1	0.3	2.6	0.3	2.4	ns					
t _{PHZ}	DIR	А	2.9	1.1	8	1	6.5	1.3	4.7	1.2	4	ns					
t _{PLZ}	DIK	A	2.9	1.1	8	1	6.5	1.3	4.7	1.2	4	115					
t _{PHZ}	DIR	В	3.4	0.5	6.6	0.3	5.6	0.3	4.6	1.1	3.5	~~					
t _{PLZ}	DIR	Б	3.4	0.5	6.6	0.3	5.6	0.3	4.6	1.1	3.5	ns					
t _{PZH} ⁽¹⁾	DIR	А	5.5		6.9		6.6		6.2		5.9	20					
t _{PZL} ⁽¹⁾	UIK	A	5.5		6.9		6.6		6.2		5.9	ns					
t _{PZH} ⁽¹⁾	חוח	Р	5.4		12.7		10.3		7.4		6.3						
t _{PZL} ⁽¹⁾	DIR	DIR	DIR	DIR	DIR	DIR	В	5.4		12.7		10.3		7.4		6.3	ns

(1) The enable time is a calculated value, derived using the formula shown in the enable times section.

Operating Characteristics

 $T_A = 25^{\circ}C$

P	ARAMETER	TEST CONDITIONS	V _{CCA} = V _{CCB} = 1.2 V	V _{CCA} = V _{CCB} = 1.5 V	V _{CCA} = V _{CCB} = 1.8 V	V _{CCA} = V _{CCB} = 2.5 V	V _{CCA} = V _{CCB} = 3.3 V	UNIT	
		CONDITIONO	TYP	TYP	TYP	TYP	TYP		
C (1)	A-port input, B-port output	$C_{L} = 0,$	3	3	3	3	4	pF	
C _{pdA} ⁽¹⁾	B-port input, A-port output	f = 10 MHz, $t_r = t_f = 1 \text{ ns}$	12	13	13	14	15	рг	
C (1)	A-port input, B-port output	$C_{L} = 0,$	12	13	13	14	15	۳Ľ	
C _{pdB} ⁽¹⁾	B-port input, A-port output	f = 10 MHz, $t_r = t_f = 1 \text{ ns}$	3	3	3	3	4	pF	

(1) Power-dissipation capacitance per transceiver



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Power-Up Considerations

A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies. To guard against such power-up problems, take the following precautions:

- 1. Connect ground before any supply voltage is applied.
- 2. Power up V_{CCA}.
- 3. V_{CCB} can be ramped up along with or after V_{CCA} .

V		V _{CCA}								
V _{CCB}	0 V	1.2 V	1.5 V	1.8 V	2.5 V	3.3 V	UNIT			
0 V	0	<0.5	<0.5	<0.5	<0.5	<0.5				
1.2 V	<0.5	<1	<1	<1	<1	1				
1.5 V	<0.5	<1	<1	<1	<1	1				
1.8 V	<0.5	<1	<1	<1	<1	<1	μΑ			
2.5 V	<0.5	1	<1	<1	<1	<1				
3.3 V	<0.5	1	<1	<1	<1	<1				

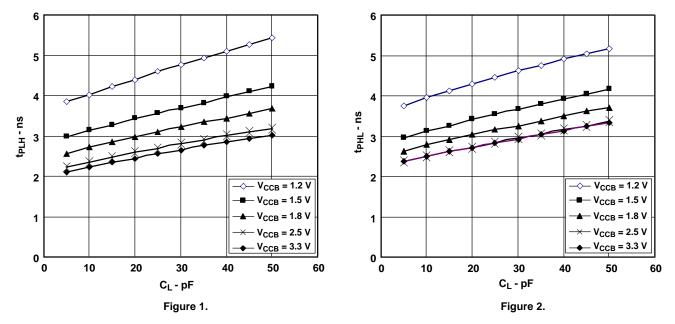
Table 1. Typical Total Static Power Consumption (I_{CCA} + I_{CCB})



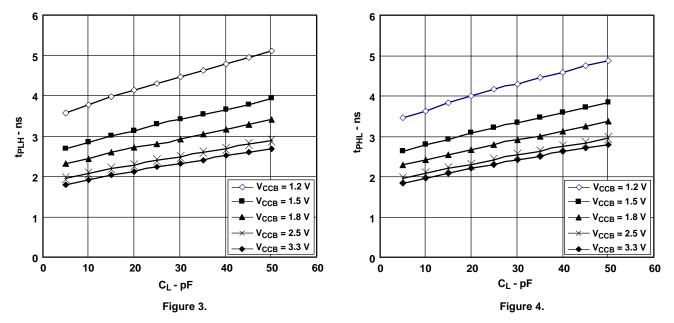
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TYPICAL CHARACTERISTICS

TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}C$, $V_{CCA} = 1.2 V$



TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}C$, $V_{CCA} = 1.5 V$

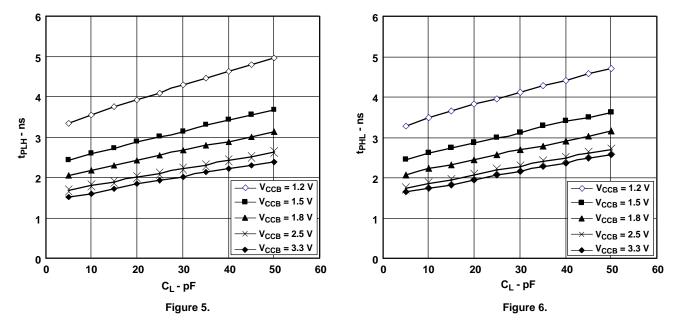


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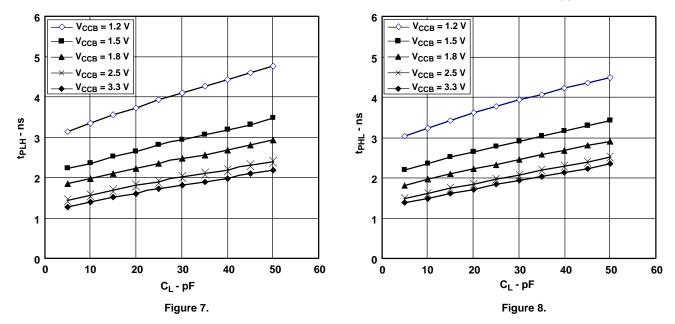


TYPICAL CHARACTERISTICS

TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}C$, $V_{CCA} = 1.8 V$



TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}C$, $V_{CCA} = 2.5 V$

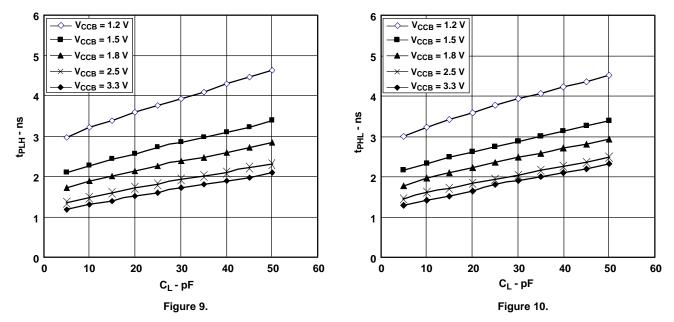


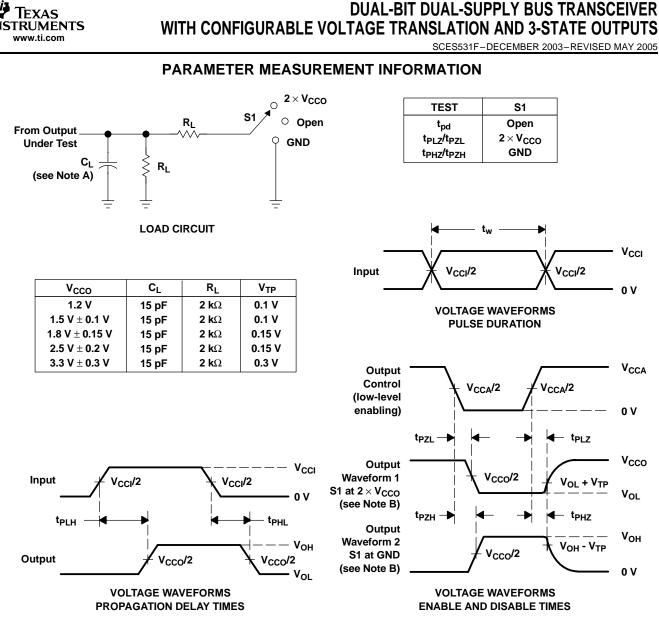


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TYPICAL CHARACTERISTICS

TYPICAL PROPAGATION DELAY (A to B) vs LOAD CAPACITANCE, $T_A = 25^{\circ}C$, $V_{CCA} = 3.3 V$





NOTES: A. CL includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control. C. All input pulses are supplied by generators having the following characteristics: $PRR \le 10$ MHz, $Z_O = 50 \Omega$, $dv/dt \ge 1$ V/ns.
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. V_{CCI} is the V_{CC} associated with the input port.
- I. V_{CCO} is the V_{CC} associated with the output port.

Figure 11. Load Circuit and Voltage Waveforms

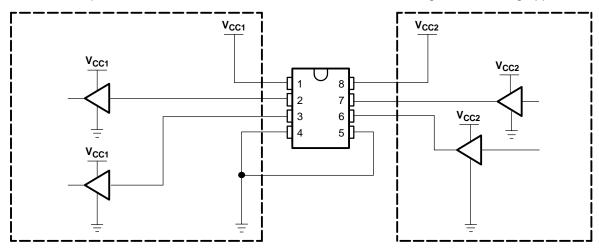
SN74AVC2T45



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APPLICATION INFORMATION

Figure 12 is an example circuit of the SN74AVC2T45 used in a bidirectional logic level-shifting application.



SYSTEM-1

SYSTEM-2

PIN	NAME	FUNCTION	DESCRIPTION
1	V _{CCA}	V _{CC1}	SYSTEM-1 supply voltage (1.2 V to 3.6 V)
2	A1	OUT1	Output level depends on V _{CC1} voltage.
3	A2	OUT2	Output level depends on V _{CC1} voltage.
4	GND	GND	Device GND
5	DIR	DIR	The GND (low-level) determines B-port to A-port direction.
6	B2	IN2	Input threshold value depends on V _{CC2} voltage.
7	B1	IN1	Input threshold value depends on V _{CC2} voltage.
8	V _{CCB}	V _{CC2}	SYSTEM-2 supply voltage (1.2 V to 3.6 V)

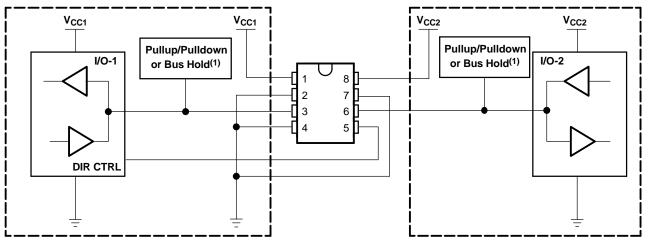
Figure 12. Bidirectional Logic Level-Shifting Application

SN74AVC2T45 DUAL-BIT DUAL-SUPPLY BUS TRANSCEIVER WITH CONFIGURABLE VOLTAGE TRANSLATION AND 3-STATE OUTPUTS

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APPLICATION INFORMATION

Figure 13 shows the SN74AVC2T45 used in a bidirectional logic level-shifting application. Since the SN74AVC2T45 does not have an output-enable (OE) pin, the system designer should take precautions to avoid bus contention between SYSTEM-1 and SYSTEM-2 when changing directions.



SYSTEM-1

SYSTEM-2

Following is a sequence that illustrates data transmission from SYSTEM-1 to SYSTEM-2 and then from SYSTEM-2 to SYSTEM-1.

STATE	DIR CTRL	I/O-1	I/O-2	DESCRIPTION
1	н	Out	In	SYSTEM-1 data to SYSTEM-2
2	н	Hi-Z	Hi-Z	SYSTEM-2 is getting ready to send data to SYSTEM-1. I/O-1 and I/O-2 are disabled. The bus-line state depends on pullup or pulldown. ⁽¹⁾
3	L	Hi-Z	Hi-Z	DIR bit is flipped. I/O-1 and I/O-2 still are disabled. The bus-line state depends on pullup or pulldown. ⁽¹⁾
4	L	Out	In	SYSTEM-2 data to SYSTEM-1

(1) SYSTEM-1 and SYSTEM-2 must use the same conditions, i.e., both pullup or both pulldown.

Figure 13. Bidirectional Logic Level-Shifting Application

Enable Times

Calculate the enable times for the SN74AVC2T45 using the following formulas:

- t_{PZH} (DIR to A) = t_{PLZ} (DIR to B) + t_{PLH} (B to A)
- t_{PZL} (DIR to A) = t_{PHZ} (DIR to B) + t_{PHL} (B to A)
- t_{PZH} (DIR to B) = t_{PLZ} (DIR to A) + t_{PLH} (A to B)
- t_{P71} (DIR to B) = t_{PH7} (DIR to A) + t_{PH1} (A to B)

In a bidirectional application, these enable times provide the maximum delay from the time the DIR bit is switched until an output is expected. For example, if the SN74AVC2T45 initially is transmitting from A to B, then the DIR bit is switched; the B port of the device must be disabled before presenting it with an input. After the B port has been disabled, an input signal applied to it appears on the corresponding A port after the specified propagation delay.



PACKAGE OPTION ADDENDUM

8-Aug-2005

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74AVC2T45DCTR	ACTIVE	SM8	DCT	8	3000	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC2T45DCTRE4	ACTIVE	SM8	DCT	8	3000	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC2T45DCTT	ACTIVE	SM8	DCT	8	250	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC2T45DCUR	ACTIVE	US8	DCU	8	3000	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC2T45DCURE4	ACTIVE	US8	DCU	8	3000	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC2T45DCUT	ACTIVE	US8	DCU	8	250	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC2T45DCUTE4	ACTIVE	US8	DCU	8	250	Pb-Free (RoHS)	CU NIPDAU	Level-1-260C-UNLIM
SN74AVC2T45YEPR	ACTIVE	WCSP	YEP	8	3000	TBD	SNPB	Level-1-260C-UNLIM
SN74AVC2T45YZPR	ACTIVE	WCSP	YZP	8	3000	Pb-Free (RoHS)	SNAGCU	Level-1-260C-UNLIM

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details. TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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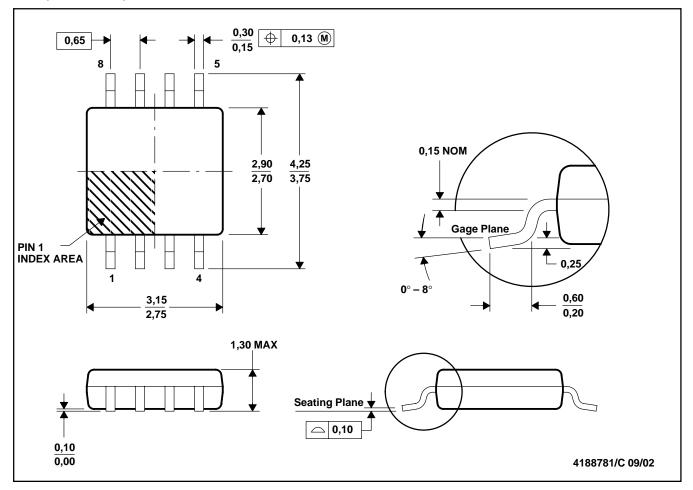
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MPDS049B - MAY 1999 - REVISED OCTOBER 2002

DCT (R-PDSO-G8)



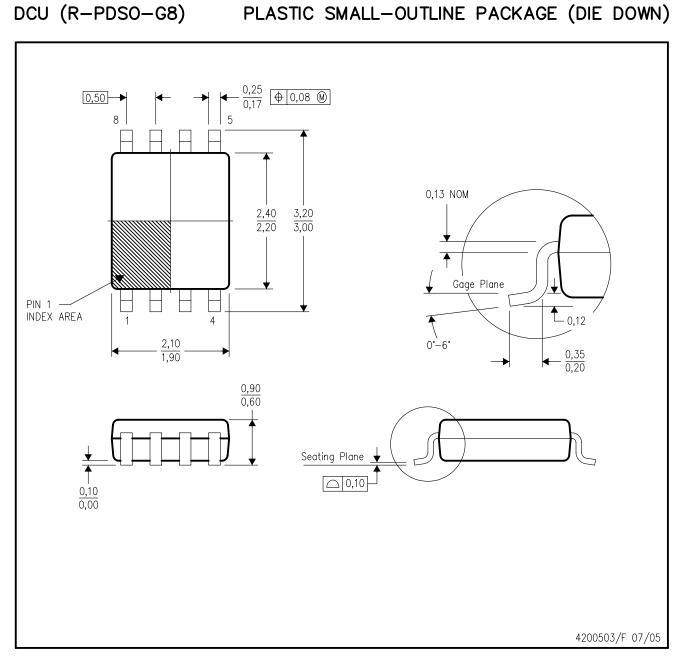


NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.C. Body dimensions do not include mold flash or protrusion

D. Falls within JEDEC MO-187 variation DA.





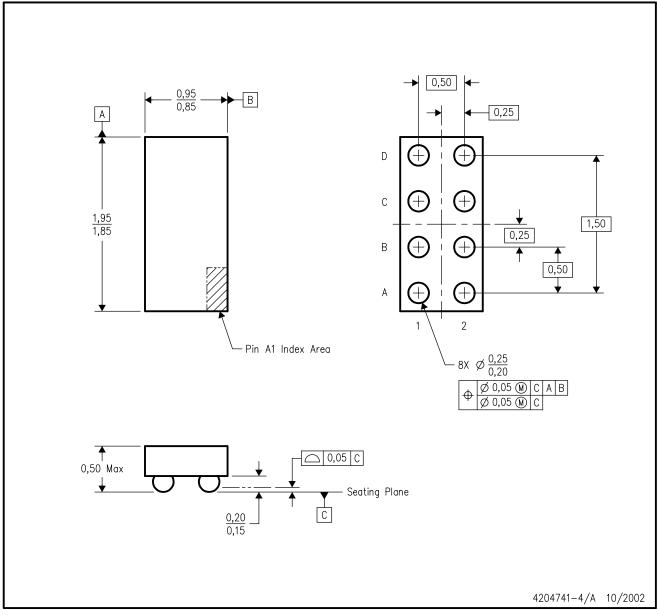
NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
- D. Falls within JEDEC MO-187 variation CA.



YZP (R-XBGA-N8)

DIE-SIZE BALL GRID ARRAY



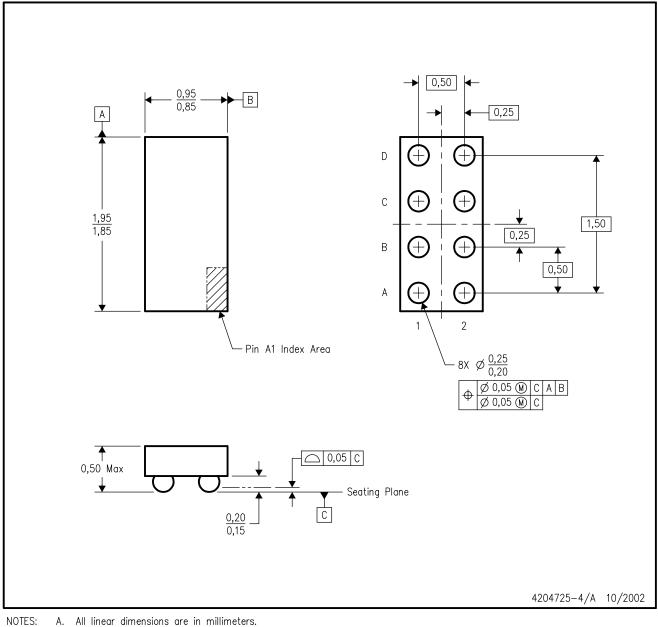
NOTES:

- A. All linear dimensions are in millimeters.B. This drawing is subject to change without notice.
- C. NanoFree™ package configuration.
- D. This package is lead-free. Refer to the 8 YEP package (drawing 4204725) for tin-lead (SnPb).

NanoFree is a trademark of Texas Instruments.

YEP (R-XBGA-N8)

DIE-SIZE BALL GRID ARRAY



NOTES:

- This drawing is subject to change without notice. Β.
- C. NanoStar™ package configuration.
- D. This package is tin-lead (SnPb). Refer to the 8 YZP package (drawing 4204741) for lead-free.

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